

Parameter	Rating	Units
Blocking Voltage	60	V <sub>P</sub>
Load Current	400	mA <sub>rms</sub> / mA <sub>DC</sub>
On-Resistance (max)	2	Ω
LED Current to operate	2	mA

## Features

- Designed for use in Security Systems Complying with EN50130-4
- 1500V<sub>rms</sub> Input/Output Isolation
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- Tape & Reel Version Available
- Small 8-Pin SOIC Package
- Flammability Rating UL 94 V-0

## Applications

- Security
  - Passive Infrared Detectors (PIR)
  - Data Signalling
  - Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Medical Equipment—Patient/Equipment Isolation
- Industrial Controls

## Description

The CPC2014N is a miniature device with two independent normally-open (1-Form-A) solid state relays in an 8-pin SOIC package that employs optically coupled MOSFET technology to provide 1500V<sub>rms</sub> of input to output isolation.

Optically coupled outputs that use the patented OptoMOS architecture are controlled by a highly efficient infrared LED.

The CPC2014N uses IXYS Integrated Circuits' state of the art, double-molded vertical construction packaging to produce one of the world's smallest relays. The CPC2014N offers substantial board space savings over the competitor's larger 8-pin SOIC relay.

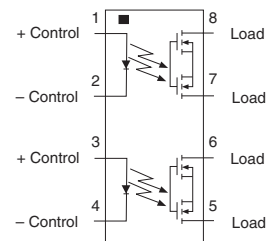
## Approvals

- UL Recognized Component: File E76270
- TUV EN 62368-1: Certificate # B 082667 0008

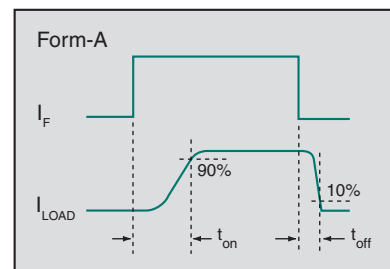
## Ordering Information

Part #	Description
CPC2014N	8-Pin SOIC (50/tube)
CPC2014NTR	8-Pin SOIC (2000/reel)

## Pin Configuration



## Switching Characteristics of Normally-Open (Form A) Devices



### Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current Peak (10ms)	50	mA
	1	A
Input Power Dissipation	70	mW
Total Power Dissipation <sup>1</sup>	600	mW
Isolation Voltage, Input to Output	1500	V <sub>rms</sub>
Operational Temperature, Ambient	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate linearly 5mW / °C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

*Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.*

### Electrical Characteristics @ 25°C

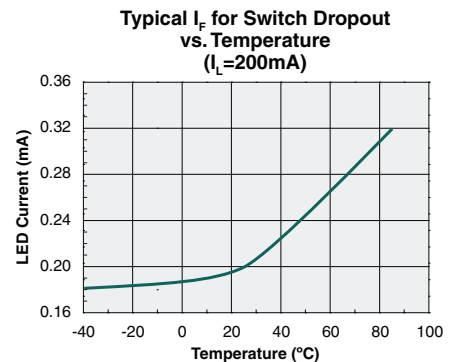
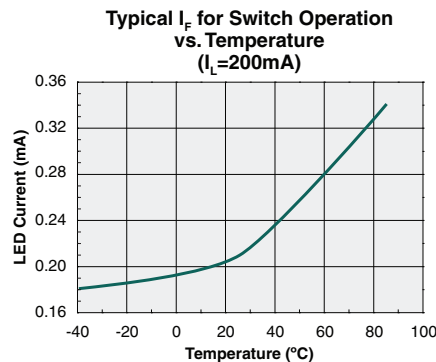
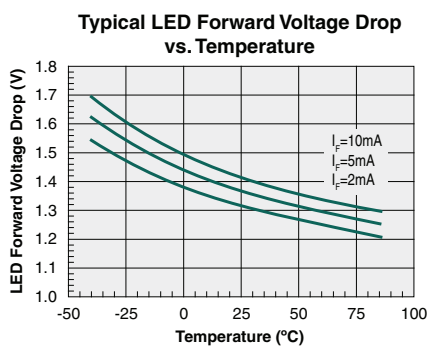
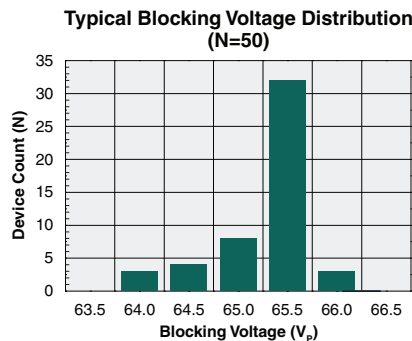
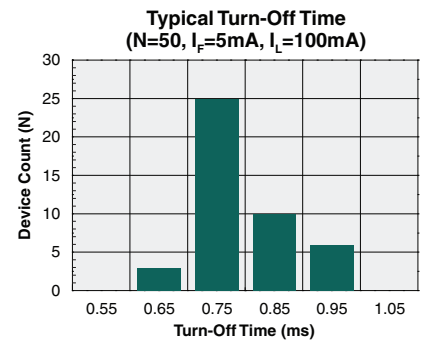
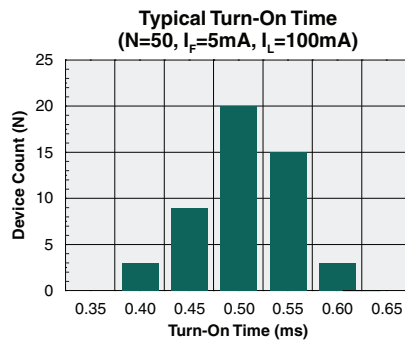
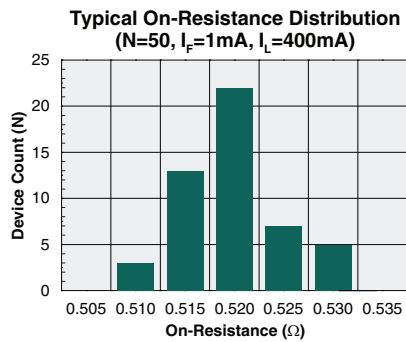
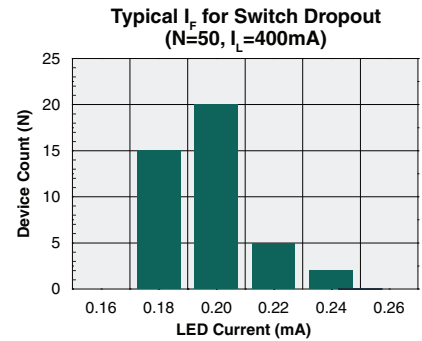
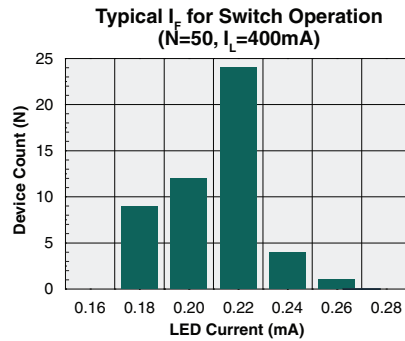
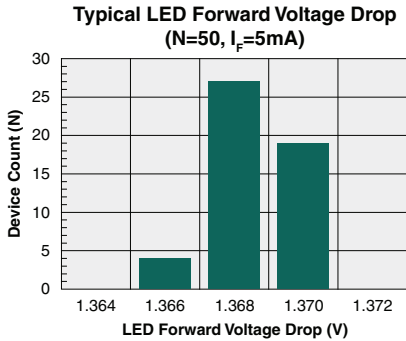
Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Blocking Voltage	I <sub>L</sub> =1μA	V <sub>DRM</sub>	60	-	-	V
Load Current	I <sub>F</sub> =2mA	I <sub>L</sub>	-	-	400	mA <sub>rms</sub> / mA <sub>DC</sub>
On-Resistance <sup>2</sup>	I <sub>L</sub> =400mA	R <sub>ON</sub>	-	-	2	Ω
Off-State Leakage Current	V <sub>L</sub> =60V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μA
<b>Switching Speeds</b>						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	0.47	2	ms
Turn-Off		t <sub>off</sub>	-	0.22	1	
Output Capacitance	I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	25	-	pF
Capacitance, Input to Output	V <sub>IO</sub> =0V, f=1MHz	C <sub>IO</sub>	-	1	-	pF
<b>Input Characteristics</b>						
Input Control Current to Activate <sup>3</sup>	I <sub>L</sub> =400mA	I <sub>F</sub>	-	0.25	2	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	0.2	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.36	1.5	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA

<sup>1</sup> Load current derates linearly from 400mA @ 25°C to 200mA @ 80°C, and must be derated for both poles operating simultaneously.

<sup>2</sup> Measurement taken within 1 second of on-time.

<sup>3</sup> For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 4mA is recommended.

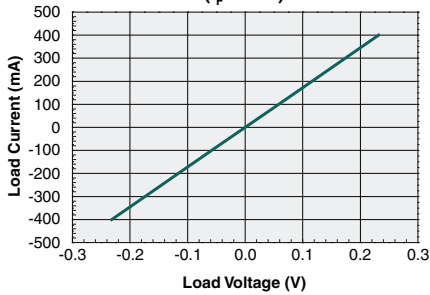
PERFORMANCE DATA\*



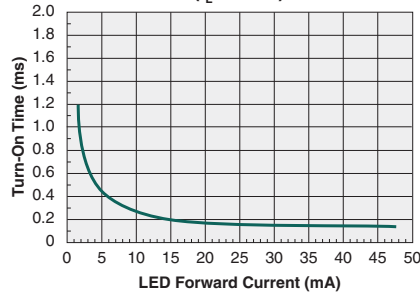
\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.

**PERFORMANCE DATA\***

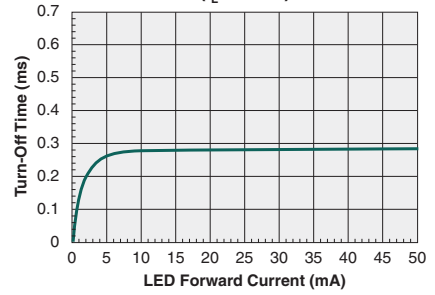
**Typical Load Current vs. Load Voltage with One Pole Operating ( $I_F=2mA$ )**



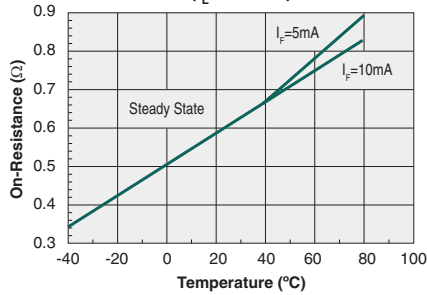
**Typical Turn-On Time vs. LED Forward Current ( $I_L=80mA$ )**



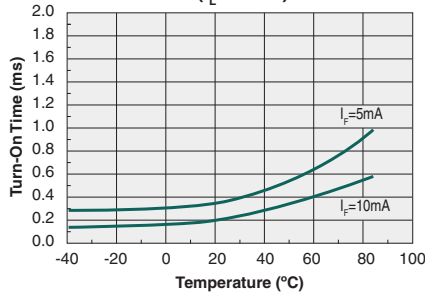
**Typical Turn-Off Time vs. LED Forward Current ( $I_L=80mA$ )**



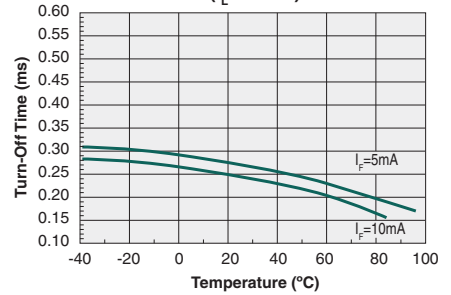
**Typical On-Resistance vs. Temperature ( $I_L=200mA$ )**



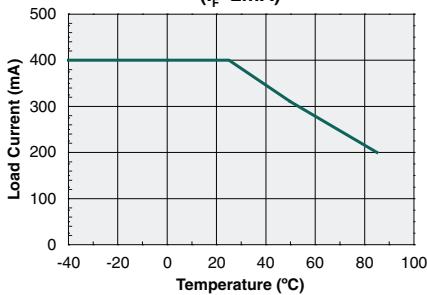
**Typical Turn-On Time vs. Temperature ( $I_L=80mA$ )**



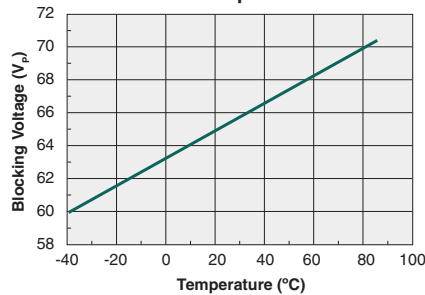
**Typical Turn-Off Time vs. Temperature ( $I_L=80mA$ )**



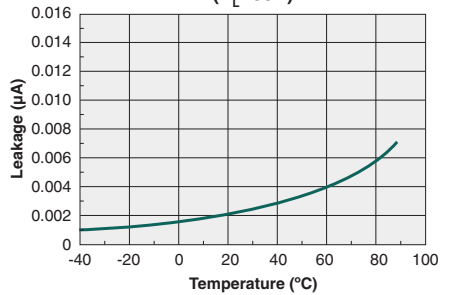
**Maximum Load Current vs. Temperature with One Pole Operating ( $I_F=2mA$ )**



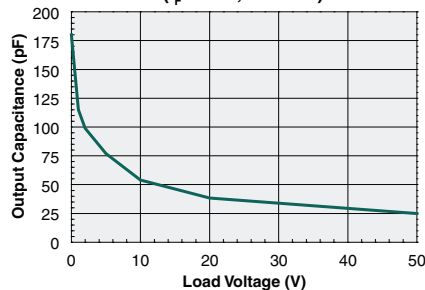
**Typical Blocking Voltage vs. Temperature**



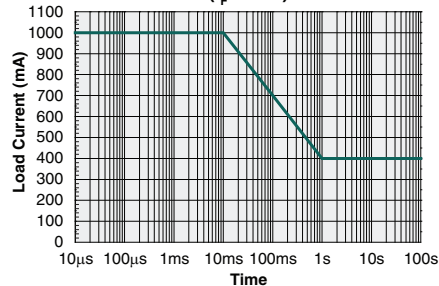
**Typical Leakage vs. Temperature Measured Across Pins 5&6 and 7&8 ( $V_L=60V$ )**



**Output Capacitance vs. Load Voltage ( $I_F=0mA, f=1MHz$ )**



**Energy Rating Curve ( $I_F=2mA$ )**



\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.

## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL)** classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC2014N	MSL 3

### ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard **JESD-625**.

### Soldering Profile

Provided in the table below is the **IPC/JEDEC J-STD-020** Classification Temperature ( $T_C$ ) and the maximum dwell time the body temperature of these surface mount devices may be ( $T_C - 5$ )°C or greater. The Classification Temperature sets the Maximum Body Temperature allowed for these devices during reflow soldering processes.

Device	Classification Temperature ( $T_C$ )	Dwell Time ( $t_p$ )	Max Reflow Cycles
CPC2014N	260°C	30 seconds	3

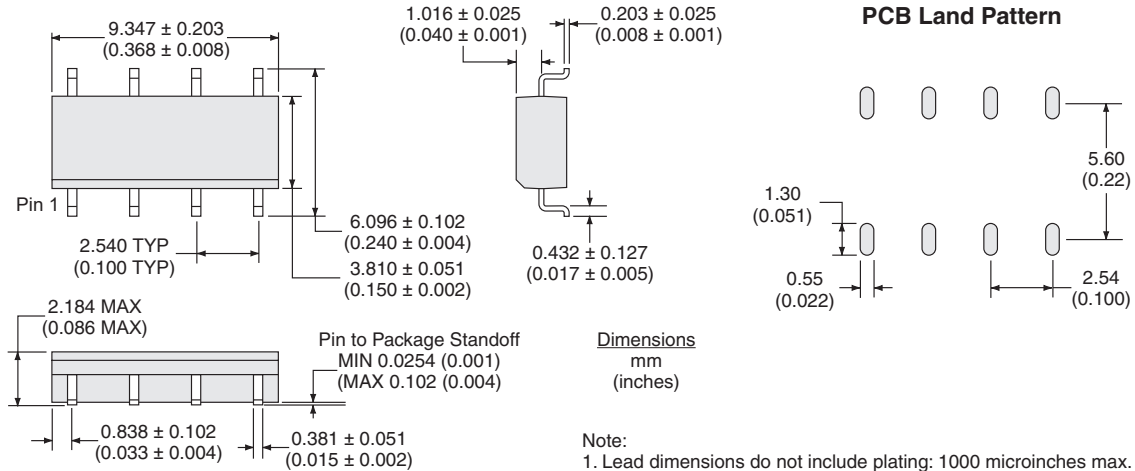
### Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to halide flux or solvents.

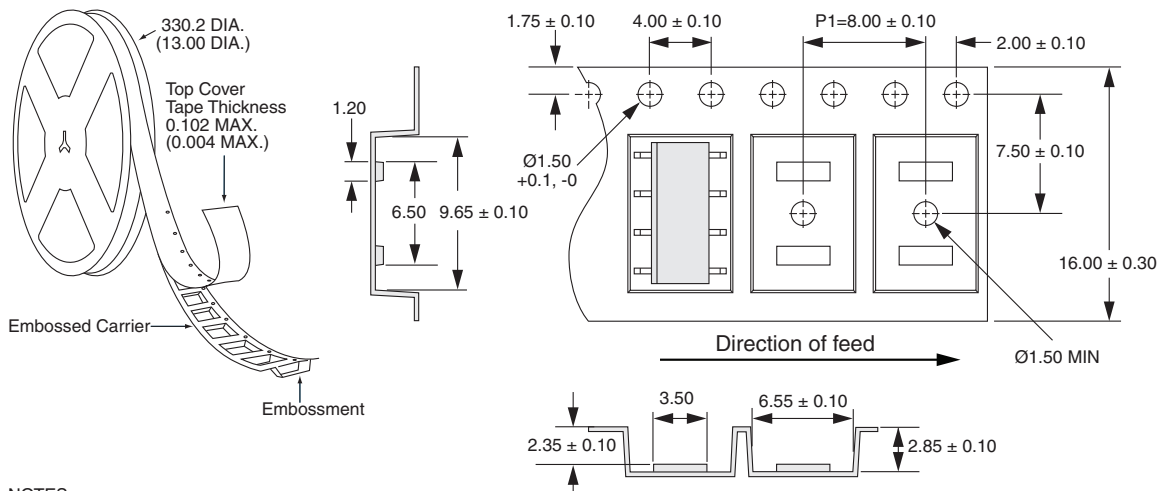


### MECHANICAL DIMENSIONS

#### CPC2014N



#### CPC2014NTR Tape & Reel



NOTES:

1. All dimensions in millimeters
2. 10 sprocket hole pitch cumulative tolerance ± 0.20.
3. Carrier camber is within 1mm in 250mm.
4. Tape material : Black Conductive Polystyrene Alloy.
5. All dimensions meet EIA-481-C requirements.
6. Thickness : 0.30 ± 0.05mm.

For additional information please visit our website at: <https://www.ixysic.com>